



### Product Summary

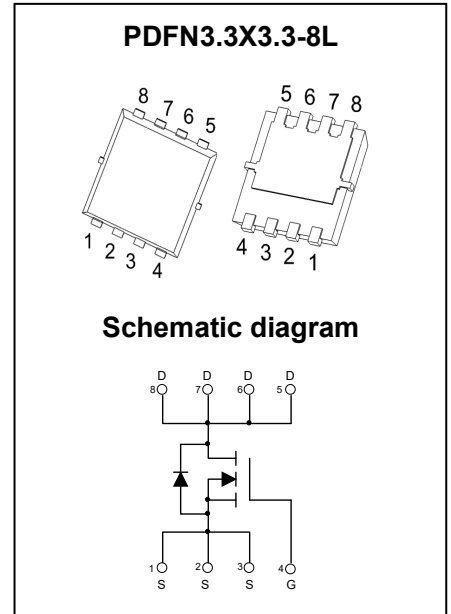
| $V_{(BR)DSS}$ | $R_{DS(on)TYP}$     | $I_D$ |
|---------------|---------------------|-------|
| 60V           | 11.5m $\Omega$ @10V | 30A   |
|               | 14m $\Omega$ @4.5V  |       |

### Feature

- Split Gate Trench Technology
- Low  $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

### Application

- Power Management
- Load Switching



### Package Marking and Ordering Information

| Part Number  | Package        | Marking  | Packing     | Reel Size | Tape Width | Qty     |
|--------------|----------------|----------|-------------|-----------|------------|---------|
| GPT130N06LNA | PDFN3.3X3.3-8L | T130N06L | Reel & Tape | 330mm     | 12mm       | 5000pcs |

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Parameter  | Symbol          | Value                     | Unit               |
|--|-----------------|---------------------------|--------------------|
| Drain-Source Voltage                                     | $V_{DS}$        | 60                        | V                  |
| Gate-Source Voltage                                      | $V_{GS}$        | $\pm 20$                  | V                  |
| Continuous Drain Current <sup>1</sup>                    | $I_D$           | $T_C = 25^\circ\text{C}$  | 30                 |
|  |                 | $T_C = 100^\circ\text{C}$ | 19                 |
| Pulsed Drain Current <sup>2</sup>                        | $I_{DM}$        | 120                       | A                  |
| Single Pulsed Avalanche Current <sup>3</sup>             | $I_{AS}$        | 13                        | A                  |
| Single Pulsed Avalanche Energy <sup>3</sup>              | $E_{AS}$        | 42                        | mJ                 |
| Power Dissipation <sup>5</sup>                           | $P_D$           | 31                        | W                  |
| Thermal Resistance from Junction to Ambient <sup>6</sup> | $R_{\theta JA}$ | 45                        | $^\circ\text{C/W}$ |
| Thermal Resistance from Junction to Case                 | $R_{\theta JC}$ | 4.1                       | $^\circ\text{C/W}$ |
| Operating Junction and Storage Temperature Range         | $T_J, T_{STG}$  | -55~ +150                 | $^\circ\text{C}$   |

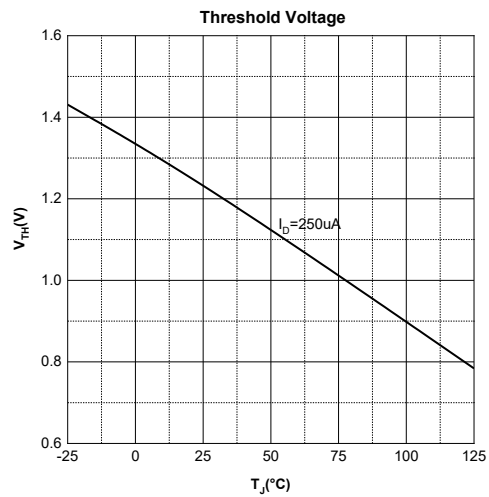
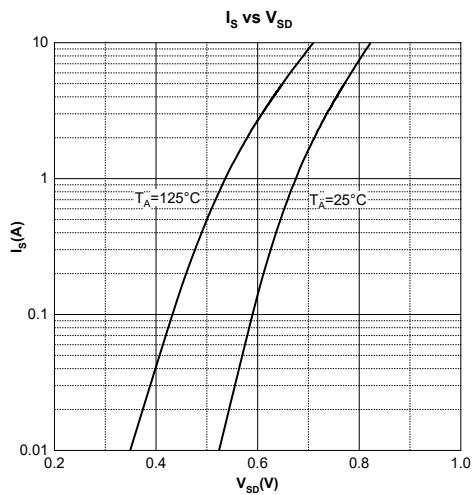
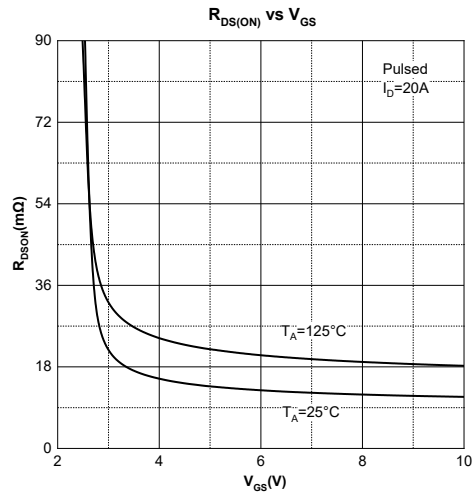
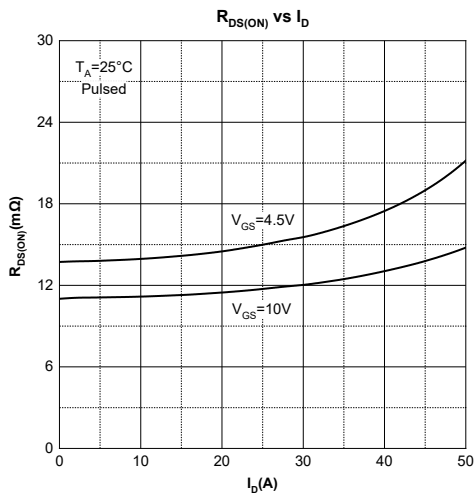
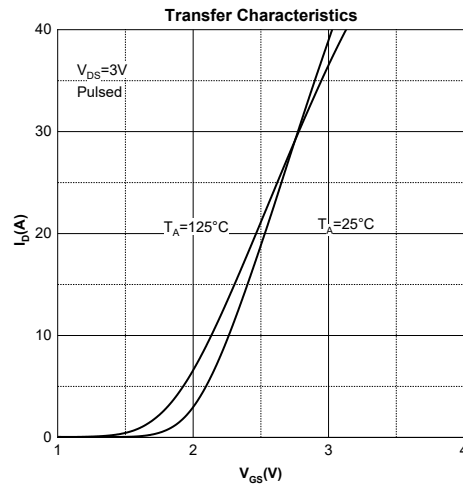
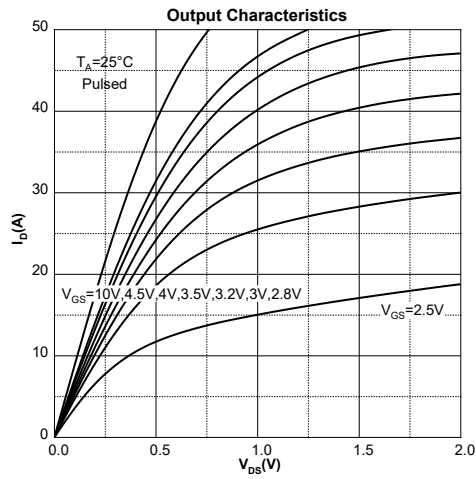
## MOSFET ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

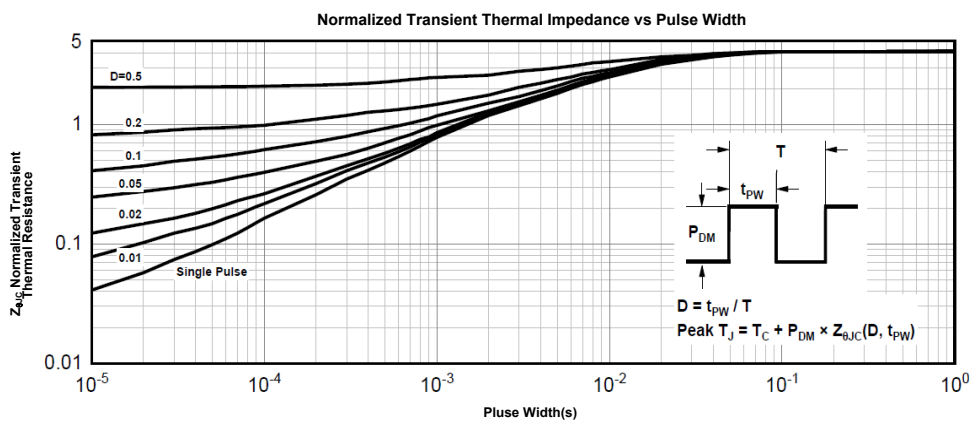
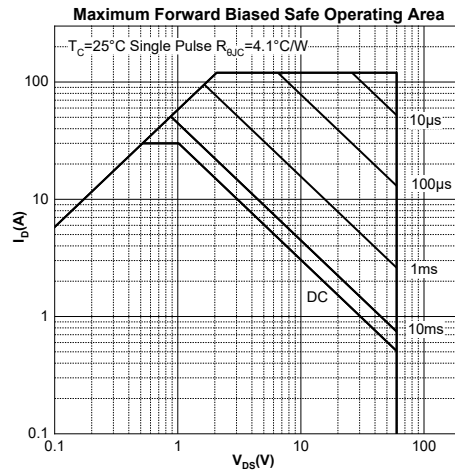
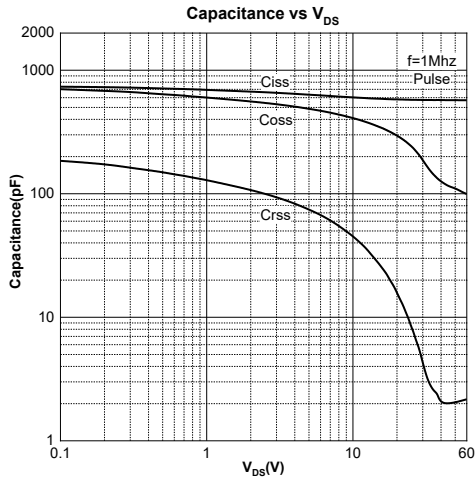
| Parameter                                     | Symbol        | Test Condition   | Min | Type | Max       | Unit       |
|---|---------------|--|-----|------|-----------|------------|
| <b>Off Characteristics</b>                    |               |  |     |      |           |            |
| Drain-Source Breakdown Voltage                | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$                              | 60  |      |           | V          |
| Zero Gate Voltage Drain Current               | $I_{DSS}$     | $V_{DS} = 60V, V_{GS} = 0V$                                |     |      | 1         | $\mu A$    |
| Gate-Body Leakage Current                     | $I_{GSS}$     | $V_{GS} = \pm 20V, V_{DS} = 0V$                            |     |      | $\pm 100$ | nA         |
| <b>On Characteristics<sup>4</sup></b>         |               |  |     |      |           |            |
| Gate Threshold Voltage                        | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\mu A$                          | 1   | 1.3  | 1.8       | V          |
| Drain-Source On-Resistance                    | $R_{DS(on)}$  | $V_{GS} = 10V, I_D = 20A$                                  |     | 11.5 | 15        | m $\Omega$ |
|   |               | $V_{GS} = 4.5V, I_D = 10A$                                 |     | 14   | 21        |            |
| <b>Dynamic Characteristics</b>                |               |  |     |      |           |            |
| Input Capacitance                             | $C_{iss}$     | $V_{DS} = 30V, V_{GS} = 0V, f = 1MHz$                      |     | 575  |           | pF         |
| Output Capacitance                            | $C_{oss}$     |  |     | 193  |           |            |
| Reverse Transfer Capacitance                  | $C_{rss}$     |  |     | 5    |           |            |
| Gate Resistance                               | $R_g$         | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$                       |     | 1.6  |           | $\Omega$   |
| <b>Switching Characteristics</b>              |               |  |     |      |           |            |
| Total Gate Charge                             | $Q_g$         | $V_{DS} = 300V, V_{GS} = 10V, I_D = 20A$                   |     | 12   |           | nC         |
| Gate-Source Charge                            | $Q_{gs}$      |  |     | 1.1  |           |            |
| Gate-Drain Charge                             | $Q_{gd}$      |  |     | 2.9  |           |            |
| Gate Plateau Voltage                          | $V_{plateau}$ |  |     | 2.7  |           | V          |
| Turn-On Delay Time                            | $t_{d(on)}$   | $V_{DD} = 30V, V_{GS} = 10V, R_G = 6\Omega, R_L = 2\Omega$ |     | 3.7  |           | ns         |
| Turn-On Rise Time                             | $t_r$         |  |     | 4.3  |           |            |
| Turn-Off Delay Time                           | $t_{d(off)}$  |  |     | 16   |           |            |
| Turn-Off Fall Time                            | $t_f$         |  |     | 6.5  |           |            |
| <b>Source-Drain Diode Characteristics</b>     |               |  |     |      |           |            |
| Diode Forward Voltage <sup>4</sup>            | $V_{SD}$      | $V_{GS} = 0V, I_S = 20A$                                   |     |      | 1.2       | V          |
| Diode Continuous Forward Current <sup>1</sup> | $I_S$         | $T_C = 25^\circ\text{C}$                                   |     |      | 40        | A          |
| Diode Pulse Forward Current <sup>2</sup>      | $I_{SM}$      |  |     |      | 160       | A          |
| Diode Reverse Recovery Time                   | $t_{rr}$      | $I_F = 15A, di/dt = 100A/\mu s$                            |     | 24   |           | ns         |
| Diode Reverse Recovery Charge                 | $Q_{rr}$      |  |     |      | 9.3       |            |

Notes:

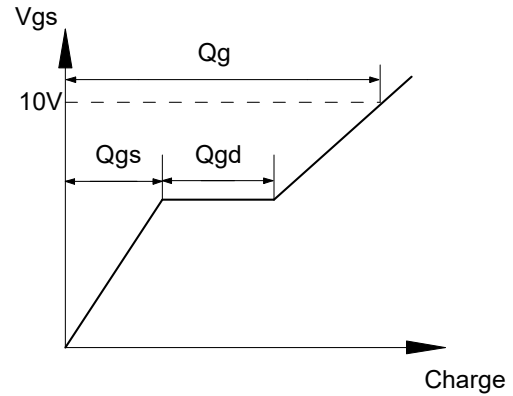
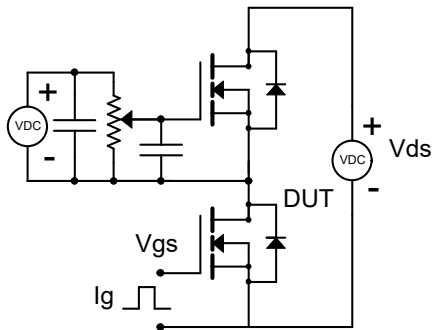
- 1.The maximum current rating is limited by package. And device mounted on a large heatsink.
- 2.Pulse Test: Pulse Width  $\leq 10\mu s$ , duty cycle  $\leq 1\%$ .
- 3.EAS condition:  $V_{DD} = 60V, V_{GS} = 10V, L = 0.5mH, R_G = 25\Omega$  Starting  $T_J = 25^\circ\text{C}$ .
- 4.Pulse Test: Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 5.The power dissipation  $P_D$  is limited by  $T_{J(MAX)} = 150^\circ\text{C}$ . And device mounted on a large heatsink.
- 6.Device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

## Typical Characteristics

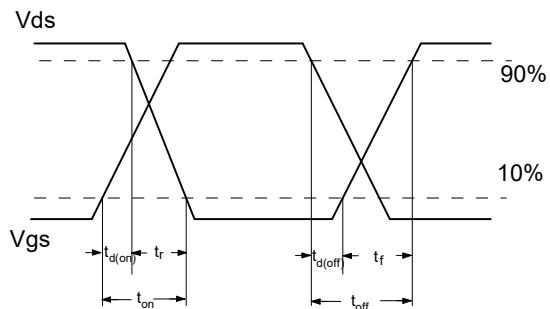
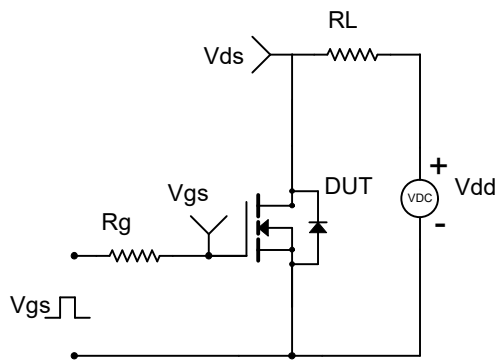




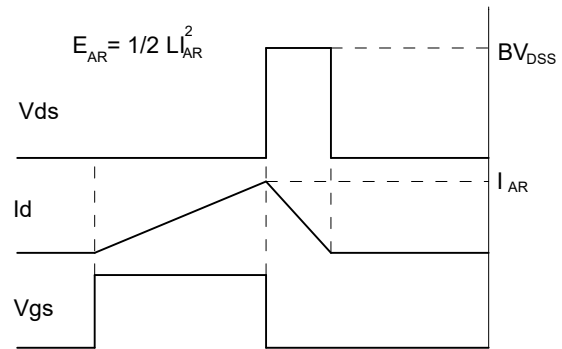
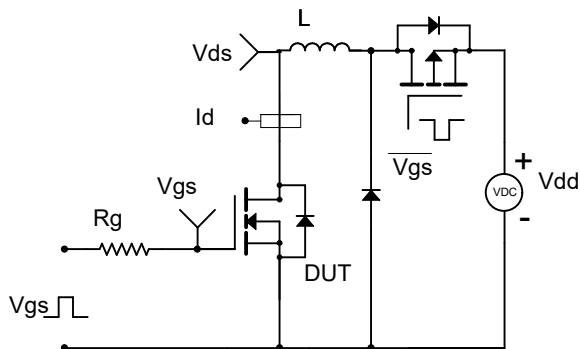
**Gate Charge Test Circuit & Waveform**



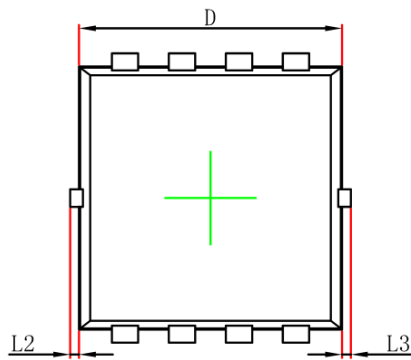
**Resistive Switching Test Circuit & Waveform**



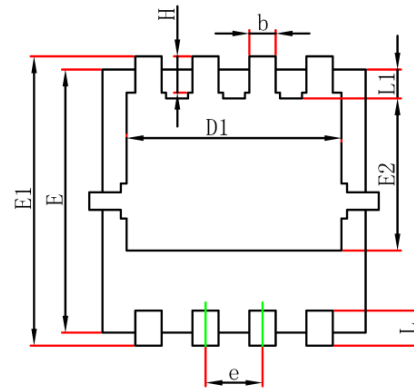
**Unclamped Inductive Switching (UIS) Test Circuit & Waveforms**



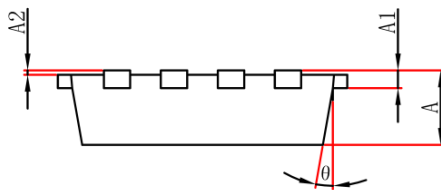
## PDFN3.3X3.3-8L Package Information



Top View  
[顶视图]



Bottom View  
[背视图]



Side View  
[侧视图]

| Symbol   | Dimensions In Millimeters |       | Dimensions In Inches |       |
|----------|---------------------------|-------|----------------------|-------|
|          | Min.                      | Max.  | Min.                 | Max.  |
| A        | 0.700                     | 0.900 | 0.028                | 0.035 |
| A1       | 0.10                      | 0.25  | 0.004                | 0.010 |
| A2       | 0.000                     | 0.050 | 0.000                | 0.002 |
| D        | 2.900                     | 3.200 | 0.114                | 0.126 |
| D1       | 2.300                     | 2.600 | 0.091                | 0.102 |
| E        | 2.900                     | 3.200 | 0.114                | 0.126 |
| E1       | 3.150                     | 3.450 | 0.124                | 0.136 |
| E2       | 1.535                     | 1.935 | 0.060                | 0.076 |
| b        | 0.200                     | 0.400 | 0.008                | 0.016 |
| e        | 0.550                     | 0.750 | 0.022                | 0.030 |
| L        | 0.300                     | 0.500 | 0.012                | 0.020 |
| L1       | 0.180                     | 0.480 | 0.007                | 0.019 |
| L2       | 0.000                     | 0.100 | 0.000                | 0.004 |
| L3       | 0.000                     | 0.100 | 0.000                | 0.004 |
| H        | 0.315                     | 0.515 | 0.012                | 0.020 |
| $\theta$ | 0°                        | 12°   | 0°                   | 12°   |

**Attention:**

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